Learn to Solder Test B

Mark the most correct answer to each question.	
1) The figure shows a a. Joint with solder not attached to the lead b. Joint with solder not attached to the pad c. Solder bridge	
2) The figure shows a a. Solder bridge b. Joint with leads not trimmed c. Good solder joint	
3) The figure shows a □ a. Good solder joint □ b. Cold solder joint □ c. Solder bridge	
4) The figure shows a □ a. Cold solder joint □ b. Good solder joint □ c. Joint with solder not attached to pad	

5) A damp sponge is used in the soldering process to ______.

□ a. Tin the tip of the iron□ b. Clean the iron's tip

☐ c. Clean the joint after soldering

6) The purpose of rosin core flux is to______. ☐ a. Give strength to the join ☐ b. Attach to the lead and the pad ☐ c. Dissolve oxides 7) The purpose of the soldering iron is to ______. ☐ a. Heat the connecting joint ☐ b. Melt the solder ☐ c. Melt the flux 8) In a good solder joint, the solder should attach to ______. ☐ a. The pad on the board ☐ b. The component lead ☐ c. All of the above 9) In a good solder joint, the lead of the component and the pad on the board are _____. ☐ a. Mechanically connected ☐ b. Electrically connected ☐ c. All of the above 10) Trimming the component leads after soldering is not a necessary step in the soldering process. ☐ True ☐ False Correct Answers:____ Grade:____ Wrong Answers: _____

Mark the most correct answer to each question.